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Advances in Sol-Gel Processes

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Deadline for manuscript submissions: **closed (31 May 2024)**

Message from the Guest Editors

This Special Issue is part of the development of materials with controlled morphology and texture synthesized by the sol–gel process.

The developed methodology in this Special Issue should integrate aspects related to the microstructure of the material, characterization of the end-use properties of the final material, and design of the manufacturing process from the laboratory to the industrial scale. This objective requires combining synthesis work, characterization work, and modeling work.











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Message from the Editor-in-Chief

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